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
Specifications and Characteristics

Specifications

Clock Sources (HP 16520A Only)	Internal Clock	
	Clock Period	programmable from 20 ns to 200 μ s in a one-two-five sequence.
	Data Period Accuracy	$\pm 2\%$ (of period) ± 1 ns
	External Clock (provided by user)	
	Input Clock Period	1 Hz to 50 MHz (20 ns min period) ECL or TTL, internal frequency divide (/1, /5, or /10) provided
	Duty Cycle	10 ns minimum high time 10 ns minimum low time
Strobes (HP 16520A Only)	Number of Strobes	3 (ECL or TTL)
	Bits/Channel	4095
	Maximum Bit Rate	20 MBit/s (50 ns period)
	Edge Placement	≤ 10 MBit/s: tenths of period > 10 MBit/s to 20 MBit/s: fifths of period (DELAY + WIDTH \leq PERIOD)
	Minimum Delay	0/10 (0/5), maximum delay is 9/10 (4/5) data period
	Minimum Width	1/10 (1/5) of data period, maximum width is the data period (values in parentheses apply to 10 MBit/s limbase setting). If strobes are desired while operating with external clock, the data rate will be divided to 1/5 or 1/10 the external clock rate.

Characteristics

Eight channel pods can be assigned as either standard ECL or TTL levels. All characteristics are valid at the probe tip.

Output	ECL	TTL
V _{OH} (steady state)	-0.98 V	2.7 V
V _{OL} (steady state)	-1.55 V (into 10k Ω , 10 pF)	0.6 V (Into 10 k Ω , 10 pF)
Risetime/ falltime (typ)	2.3 ns (-0.98 V to -1.55V)	2.5 ns ns  (0.6 V to 2.7V)
Channel-to- channel skew* (same card)	≤ 5 ns	≤ 5 ns
Channel-to- channel skew* (card-to-card)	< 10 ns	< 10 ns
Number of std loads	3 (10 KH ECL, @ V _{nh} = 150 mV)	3 (LS, @ V _{nl} = 250 mV)

(Output measurements made into a load consisting of 10 k Ω in series shunted with 10 pF to ground.)

(*) Skew measured at (+1.6 V) TTL and (-1.3 V) ECL levels.

Data Capacity

	16520A	16521A
Number of channels	12	48
Bits per channel	4095	4095
Maximum bit rate	50 MBit/s NRZ (20 ns period)	50 MBit/s NRZ (20 ns period)

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Input	ECL	TTL
V_{ih} (min)	-0.91 V	2.08 V
V_{il} (max)	-1.69 V	1.12 V
Maximum input voltage	±40 V	
Input impedance	100 kΩ, 8 pF	
External clock-in to clock-out delay	50 ns	

Editing Functions	Program Listing	DELETE, MERGE, COPY, INSERT
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Listing Bases	Binary, octal, decimal, hexadecimal, and symbol
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Step Mode	Single-step program execution in 1 to 999 program line steps, from a break.
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Data Instruction Set	Break	Stops program execution, last data vector is held at output.
	Repeat	Repeats vector up to 256 times.
	Wait IMB	Wait for intermodule trigger
	Wait External	Wait for user-defined 3-bit pattern on external input pod to become true. No data cycle latency when pattern is true between 30 ns and 0 ns before next clock edge.
	Signal IMB	Arms other measurement cards.
	Macro	Four different macros may be defined and inserted as needed. A six character name may be defined for each macro. Macros may contain

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REPEAT, WAIT EXTERNAL, WAIT IMB, BREAK
AND SIGNAL IMB instructions.

Operating Environment	Temperature	Instrument, 0° to 55° C (+32° to 131° F). Probe lead sets and cables, 0° to 65° C (+32° to 149° F).
	Humidity	Instrument, up to 95% relative humidity at 40° C (104° F).
	Altitude	To 4600 m (15,000 ft).
	Vibration Operating	Random vibration 5-500 Hz, 10 minutes per axis, ~0.3 g (rms)
	Non-operating	Random vibration 5-500 Hz, 10 minutes per axis, ~2.41 g (rms); and swept sine resonant search, 5-500 Hz, 0.75 g (0-peak), 5 minute resonant dwell @ 4 resonances per axis.